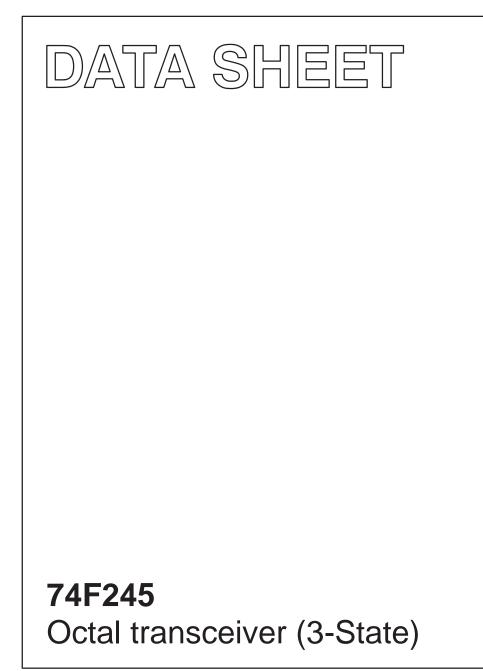
INTEGRATED CIRCUITS



Product specification

1994 Nov 15

IC15 Data Handbook

Philips Semiconductors





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74F245

FEATURES

- Octal bidirectional bus interface
- 3-State buffer outputs sink 64mA
- 15mA source current
- Outputs are placed in high impedance state during power-off conditions

DESCRIPTION

The 74F245 is an octal transceiver featuring non-inverting 3-State bus compatible outputs in both transmit and receive directions. The B port outputs are capable of sinking 64mA and sourcing 15mA, producing very good capacitive drive characteristics. The device features an Output Enable (\overline{OE}) input for easy cascading and Transmit/Receive (T/ \overline{R}) input for direction control. The 3-State outputs, B0–B7, have been designed to prevent output bus loading if the power is removed from the device.

PIN CONFIGURATIO	N	
T/R 1 A0 2 A1 3 A2 4 A3 5 A4 6		20 V _{CC} 19 OE 18 B0 17 B1 16 B2 15 B3
A4 0 A5 7 A6 8 A7 9 GND 10		14 B4 13 B5 12 B6 11 B7
	SF	00198

TYPE	TYPE TYPICAL PROPAGATION DELAY TYPICAL SUPPLY CURRENT (TOTAL			
74F245	4.0ns	70mA		

ORDERING INFORMATION

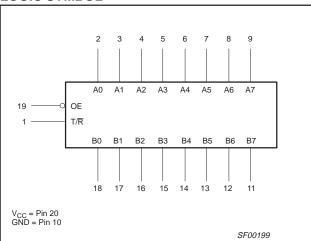
DESCRIPTION	COMMERCIAL RANGE V _{CC} = 5V ±10%, T _{amb} = 0°C to +70°C	DRAWING NUMBER
20-Pin Plastic DIP	N74F245N	SOT146-1
20-Pin Plastic SO	N74F245D	SOT163-1
20-Pin Plastic SSOP Type II	N74F245DB	SOT339-1

INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

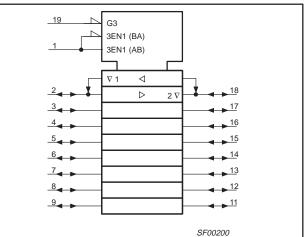
PINS	DESCRIPTION	74F (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
A0–A7, B0–B7	Data inputs	3.5/1.0	70μA/0.6mA
ŌĒ	Output Enable input (active Low)	1.0/2.0	20µA/1.2mA
T/R	Transmit/Receive input	1.0/2.0	20µA/1.2mA
A0–A7	A port outputs	150/40	3.0mA/24mA
B0–B7	B port outputs	750/106.7	15mA/64mA

NOTE: One (1.0) FAST unit load is defined as: 20µA in the High state and 0.6mA in the Low state.

LOGIC SYMBOL



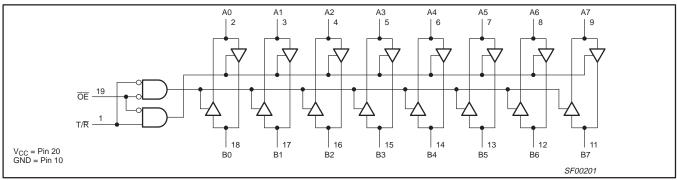
IEC/IEEE SYMBOL



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74F245

LOGIC DIAGRAM



FUNCTION TABLE

INP	JTS	OUTPUTS
OE	T/R	0012013
L	L	Bus B data to Bus A
L	Н	Bus A data to Bus B
Н	X	Z

H = High voltage level

L = Low voltage level

X = Don't care

Z = High impedance "off" state

ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limits set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER	PARAMETER					
V _{CC}	Supply voltage		-0.5 to +7.0	V			
V _{IN}	Input voltage		-0.5 to +7.0	V			
I _{IN}	Input current		-30 to +5	mA			
V _{OUT}	Voltage applied to output in High output state		-0.5 to +5.5	V			
	Current emplied to output in Low output state	A0–A7	48	mA			
OUT	Current applied to output in Low output state	B0–B7	128	mA			
T _{amb}	Operating free-air temperature range	0 to +70	°C				
T _{stg}	Storage temperature range		-65 to +150	°C			

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER		UNIT			
STMBOL	PARAMETER	MIN	NOM	MAX		
V _{CC}	Supply voltage		4.5	5.0	5.5	V
V _{IH}	High-level input voltage		2.0			V
V _{IL}	Low-level input voltage				0.8	V
I _{IK}	Input clamp current				-18	mA
	Lich lovel output ourrest	A0–A7			-3	mA
юн	High-level output current	B0–B7			-15	mA
		A0–A7			24	mA
IOL	Low-level output current	B0–B7			64	mA
T _{amb}	Operating free-air temperature range		0		+70	°C

74F245

DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	DADAMETE	B	тес	TEST CONDITIONS ¹				LIMITS		
STMBUL	PARAMETE	ĸ	163	ST CONDITION:	D'	MIN	TYP ²	MAX	UNIT	
					±10% V _{CC}	2.4			V	
		A0–A7, B0–B7	$V_{CC} = MIN,$	I _{OH} = -3mA	±5% V _{CC}	2.7	3.4		V	
V _{OH}	High-level output voltage		V _{IL} = MAX, V _{IH} = MIN		±10% V _{CC}	2.0			V	
		B0–B7		$I_{OH} = -15 mA$	±5% V _{CC}	2.0			V	
		4.0.47	V _{CC} = MIN,	I _{OL} = 20mA	±10% V _{CC}		0.30	0.50	V	
V _{OL}	Low-level output voltage	A0–A7	$V_{IL} = MAX,$	I _{OL} = 24mA	±5% V _{CC}		0.35	0.50	V	
		B0–B7	V _{IH} = MIN	I _{OL} = MAX	±10% V _{CC}			0.55	V	
V _{OL}	Low-level output voltage	B0–B7	$\begin{array}{l} V_{CC} = MIN, \\ V_{IL} = MAX, \\ V_{IH} = MIN \end{array}$	I _{OL} = MAX	±5% V _{CC}		0.42	0.55	V	
V _{IK}	Input clamp voltage	•	$V_{CC} = MIN, I_I = I_{IK}$				-0.73	-1.2	V	
	Input current at maximum OE, T/R		V _{CC} = 5.5V, V _I = 7.0V					100	μA	
t _l	input voltage	A0–A7, B0–B7	V _{CC} = 5.5V, V _I = 5.5V					1	mA	
I _{IH}	High-level input current	OE, T/R only	$V_{CC} = MAX, V_I = 2.7V$					20	μΑ	
IIL	Low-level input current	OE, T/R only	$V_{CC} = MAX, V_I = 0.5V$					-1.2	mA	
I _{IH} +I _{OZH}	Off-state output current High level voltage applied		V _{CC} = MAX, V _C	_D = 2.7V				70	μA	
I _{IL} +I _{OZL}	Off-state output current Low level voltage applied		V _{CC} = MAX, V _C	_D = 0.5V				-600	μΑ	
		A0–A7				-60		-150	mA	
I _{OS}	Short-circuit output current ³	B0–B7	V _{CC} = MAX		-100		-225	mA		
		I _{ССН}					60	87	mA	
I _{CC}	Supply current (total)	I _{CCL}	V _{CC} = MAX				70	100	mA	
		I _{CCZ}	1				75	110	mA	

NOTES:

 For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
All typical values are at V_{CC} = 5V, T_{amb} = 25°C.
Not more than one output should be shorted at a time. For testing I_{OS}, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I_{OS} tests should be performed last.

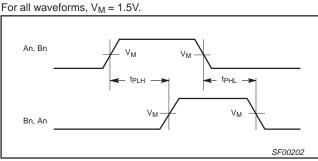
					LIM	ITS		
SYMBOL	PARAMETER	TEST CONDITION	Ta	_{CC} = +5.0 _{mb} = +25 0pF, R _L =	°C	$T_{amb} = 0^{\circ}C$	0V ± 10% C to +70°C R _L = 500Ω	UNIT
			MIN	TYP	MAX	MIN	MAX	
t _{PLH} t _{PHL}	Propagation delay An to Bn, Bn to An	Waveform 1	2.5 2.5	3.5 4.0	6.0 6.0	2.5 2.5	7.0 7.0	ns
t _{PZH} t _{PZL}	Output Enable time to High or Low level	Waveform 2 Waveform 3	2.0 3.5	4.5 5.5	7.0 8.0	2.0 3.5	8.0 9.0	ns
t _{PHZ} t _{PLZ}	Output Disable time from High or Low level	Waveform 2 Waveform 3	2.5 1.0	5.0 3.5	6.5 6.0	2.0 1.0	7.5 7.0	ns

AC ELECTRICAL CHARACTERISTICS

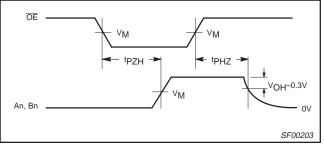
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SF00128

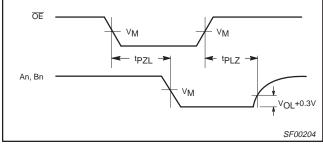
AC WAVEFORMS



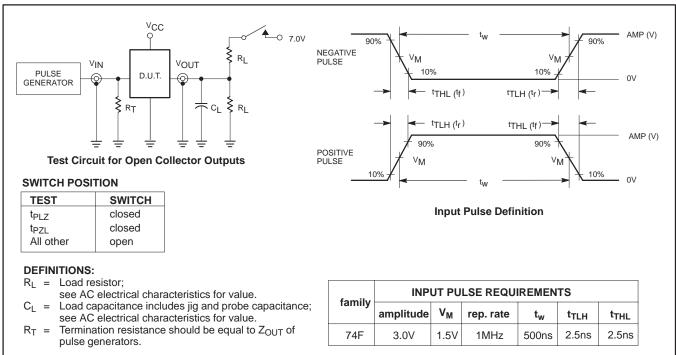
Waveform 1. Propagation Delay for Non-Inverting Output



Waveform 2. 3-State Output Enable Time to High Level and Output Disable Time from High Level



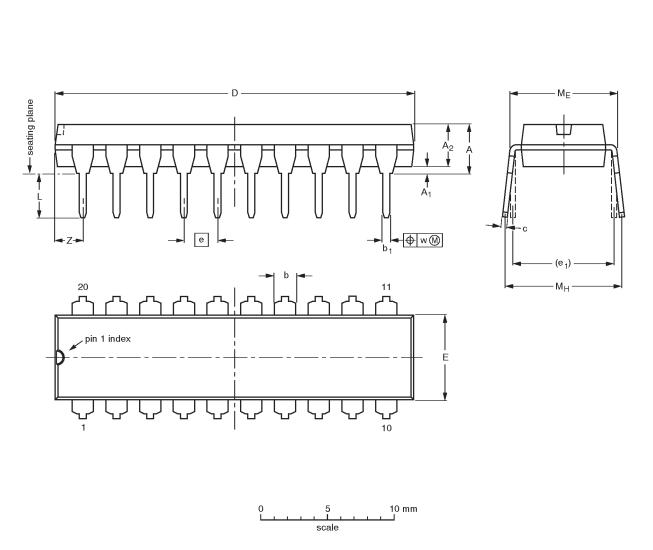
Waveform 3. 3-State Output Enable Time to Low Level and Output Disable Time from Low Level



TEST CIRCUIT AND WAVEFORMS

SOT146-1





DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	c	D ⁽¹⁾	E ⁽¹⁾	e	e ₁	L	M _E	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	0.36 0.23	26.92 26.54	6.40 6.22	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.0
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.014 0.009	1.060 1.045	0.25 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.078

Note

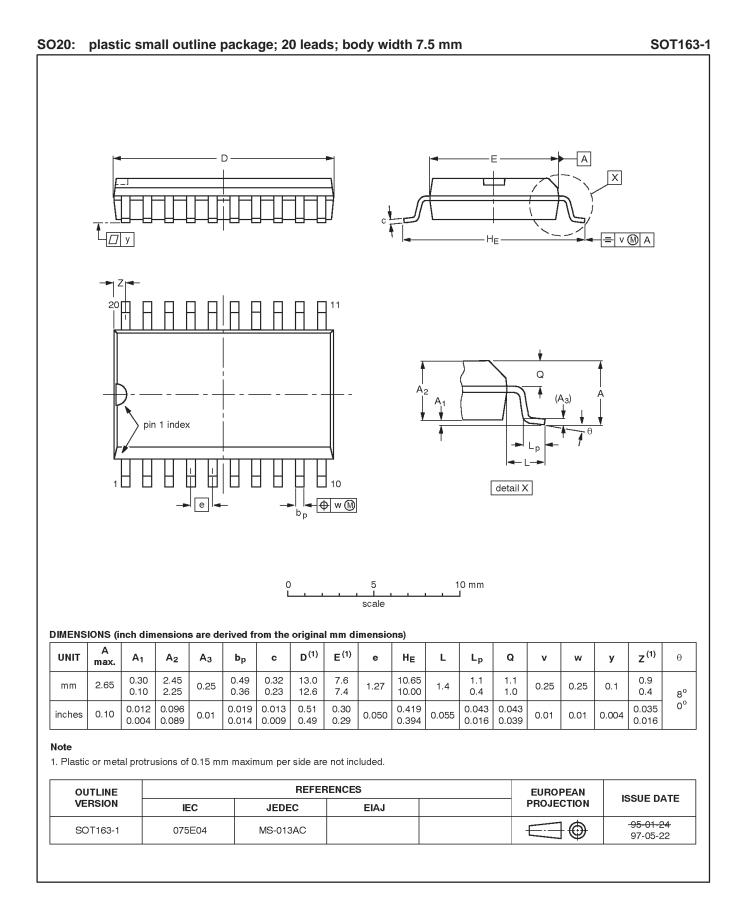
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

ſ	OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE		
	VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
	SOT146-1			SC603			-92-11-17- 95-05-24	

Product specification

Product specification

74F245



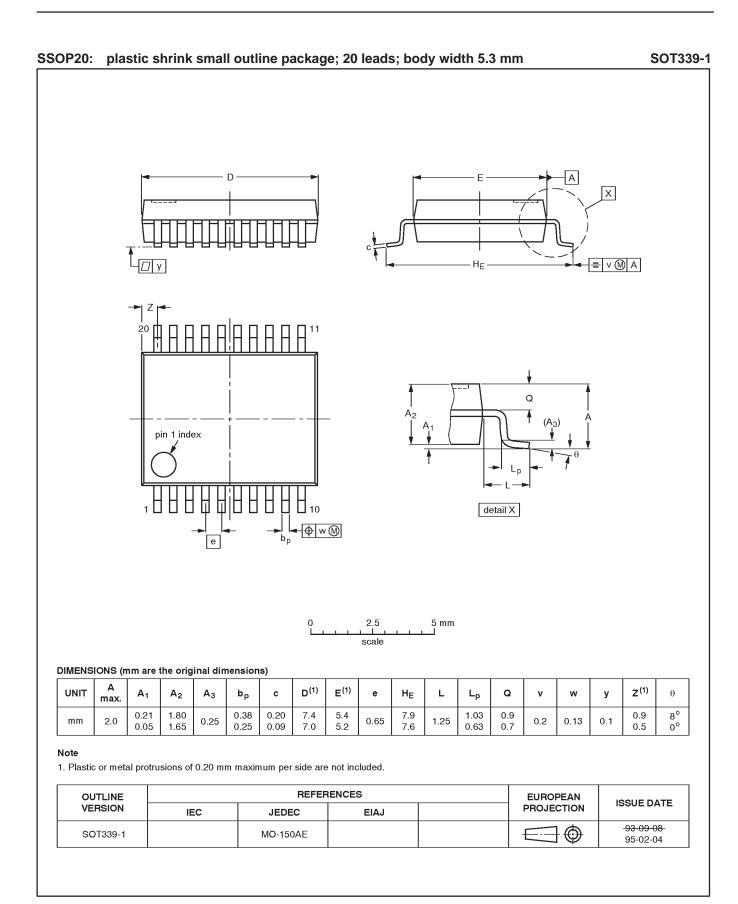
Product specification

74F245

NOTES

74F245

Product specification



74F245

	DEFINITIONS								
Data Sheet Identification Product Status Definition									
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.							
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